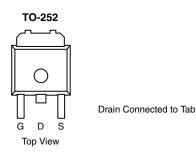


P-Channel 100 V (D-S) MOSFET

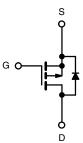
PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)	
- 100	0.043 at V _{GS} = - 10 V	- 37	54 nC	
- 100	0.048 at V _{GS} = - 4.5 V	- 35	54 110	



FEATURES

- TrenchFET[®] Power MOSFET
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912





P-Channel MOSFET

Ordering Information: SUD50P10-43L-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (TA	= 25 °C, unless othe	rwise noted)		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 100	v
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		- 36.4	
	T _C = 70 °C	1 , Г	- 29.1	
Continuous Drain Current (T _J = 150 °C) ^b	T _A = 25 °C	I _D	- 9 ^{b, c}	
	T _A = 70 °C	1	- 7.2 ^{b, c}	•
Pulsed Drain Current	I _{DM}	- 40	A	
Continuous Courses (Diada Conduction)	T _C = 25 °C		- 50 ^a	
Continuous Source Current (Diode Conduction)	T _A = 25 °C	I _S	- 5.75 ^{b, c}	1
Avalanche Current		I _{AS}	- 35	
Single Pulse Avalanche Energy	L = 0.1 mH		61	mJ
	T _C = 25 °C		113.6	
Maximum Power Dissipation	T _C = 70 °C		72.7	
	T _A = 25 °C	P _D	6.9 ^{b, c}	- W
	T _A = 70 °C	1 [4.4 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS				
	Symbol	Typical	Maximum	Unit
t ≤ 10 s	- R _{thJA}	15	18	°C/W
Steady State		40	50	
	R _{thJC}	0.85	1.1	
		$\begin{array}{c c} t \leq 10 \text{ s} \\ \hline \\ \\ \hline \\ \hline \\ \\ \\ \\ \hline \\ \\ \\ \hline \\ \\ \\ \\ \hline \\ \\ \\ \\ \\ \hline \\$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$

Notes:

a. Package limited.

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c. t = 10 s.

d. Maximum under steady state conditions is 50 °C/W.

For technical questions, contact: pmostechsupport@vishay.com

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b. Surface mounted on 1" x 1" FR4 board.

SUD50P10-43L-GE3

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	- I				•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 100			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 A		- 109		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μΑ		5.9		mV/°
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	1.
Zero Gate Voltage Drain Current	IDSS	V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 40			Α
	_	V _{GS} = - 10 V, I _D = - 9.2 A		0.036	0.043	Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 7.7 A		0.040	0.048	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 9.2 A		38		S
Dynamic ^b						
Input Capacitance	C _{iss}			4600		pF
Output Capacitance	C _{oss}	V _{DS} = - 50 V, V _{GS} = 0 V, f = 1 MHz		230		
Reverse Transfer Capacitance	C _{rss}			175		
Tatal Cata Charge	0	V _{DS} = - 50 V, V _{GS} = - 10 V, I _D = - 9.2 A		106	160	
Total Gate Charge	Qg			54	81	nC
Gate-Source Charge	Q_gs	V_{DS} = - 50 V, V_{GS} = - 4.5 V, I_D = - 9.2 A		14		nc
Gate-Drain Charge	Q _{gd}			26		1
Gate Resistance	R _g	f = 1 MHz		4		Ω
Turn-On Delay Time	t _{d(on)}			15	25	ns
Rise Time	t _r	V_{DD} = - 50 V, R_L = 6.5 Ω		20	30	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 7.7 A, V_GEN = - 10 V, R_g = 1 Ω		110	165	
Fall Time	t _f			100	150	
Turn-On Delay Time	t _{d(on)}			42	65	- ns
Rise Time	t _r	V_{DD} = - 50 V, R_L = 6.5 Ω		160	240	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 7.7 A, V_GEN = - 4.5 V, R_g = 1 Ω		100	150	
Fall Time	t _f			100	150	
Drain-Source Body Diode Characteristic	s				•	
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 50	Δ
Pulse Diode Forward Current ^a	I _{SM}				- 40	A
Body Diode Voltage	V _{SD}	I _S = - 7.7 A		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}			60	90	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 7.7 A, dl/dt = 100 A/μs, T _{.1} = 25 °C		150	225	nC
Reverse Recovery Fall Time	t _a	$T_F = -7.7 \text{ A}, \text{ al/at} = 100 \text{ A/} \mu \text{s}, T_J = 25^{\circ} \text{C}$		46		
Reverse Recovery Rise Time	t _b	1		14		ns

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

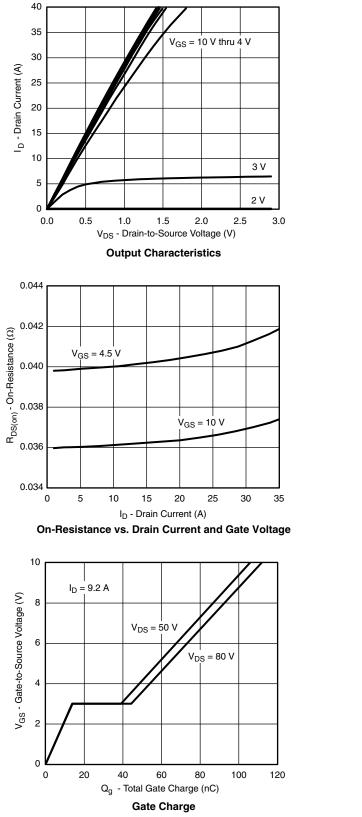
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

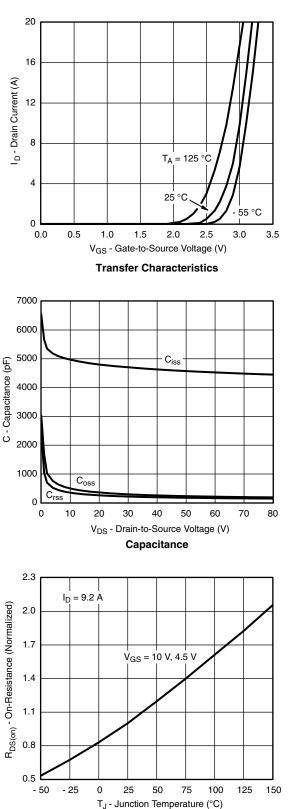


SUD50P10-43L-GE3

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On-Resistance vs. Junction Temperature

Document Number: 62504 S12-1955-Rev. B, 13-Aug-12

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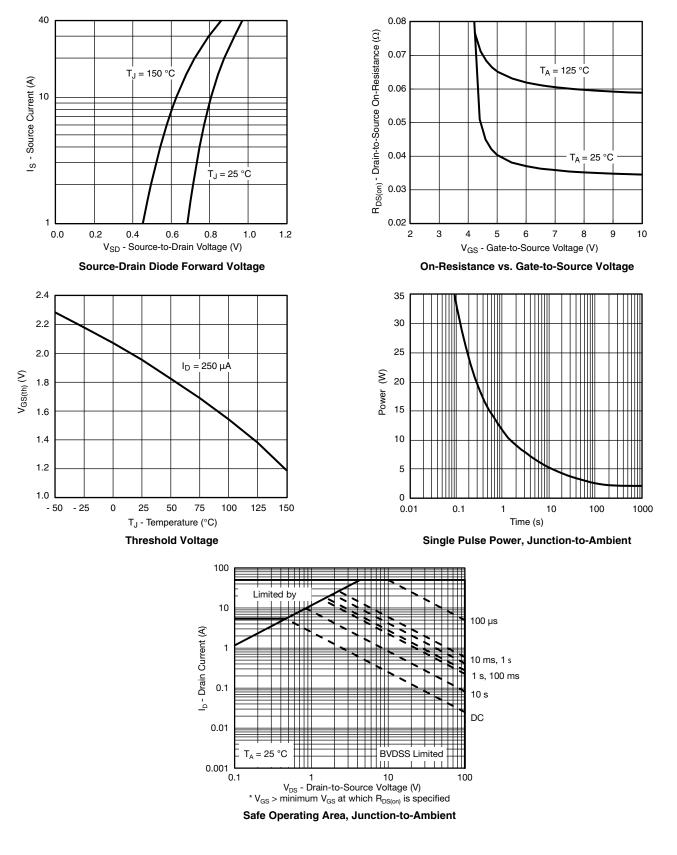
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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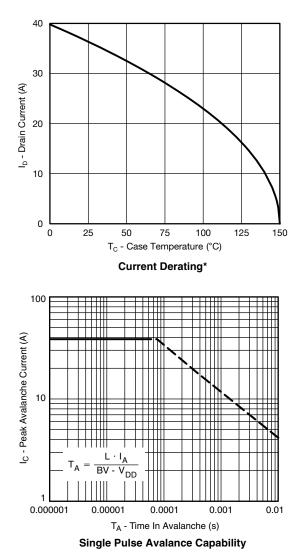
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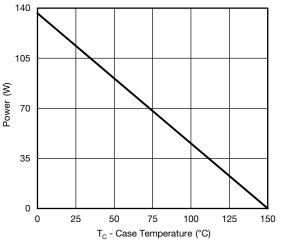


SUD50P10-43L-GE3

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Single Pulse Power, Junction-to-Ambient

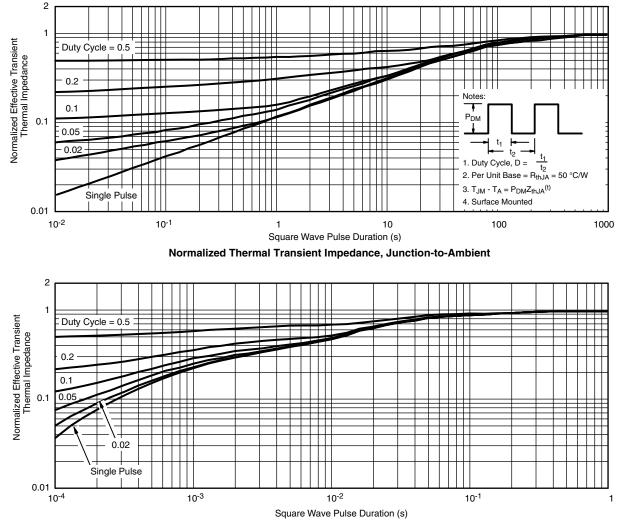
* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

/ISHA

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62504

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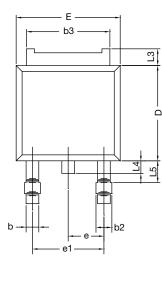
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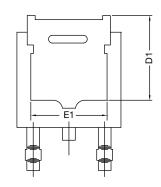


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







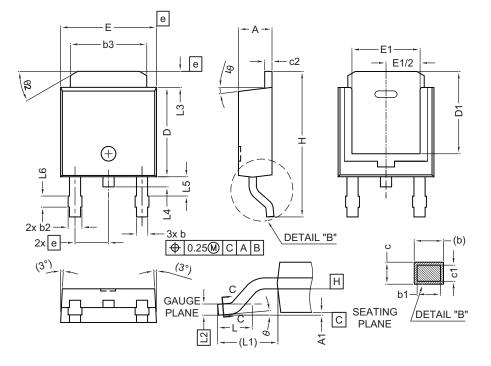
	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
E	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
с	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32	-	
e	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	1 ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

Dimensioning and tolerance confirm to ASME Y14.5M-1994

All dimensions are in millimeters. Angles are in degrees

Heat sink side flash is max. 0.8 mm

Radius on terminal is optional ٠

ECN: E19-0649-Rev. Q, 16-Dec-2019 DWG: 5347

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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